
HAT3006R

Silicon N Channel / P Channel Power MOS FET
High Speed Power Switching

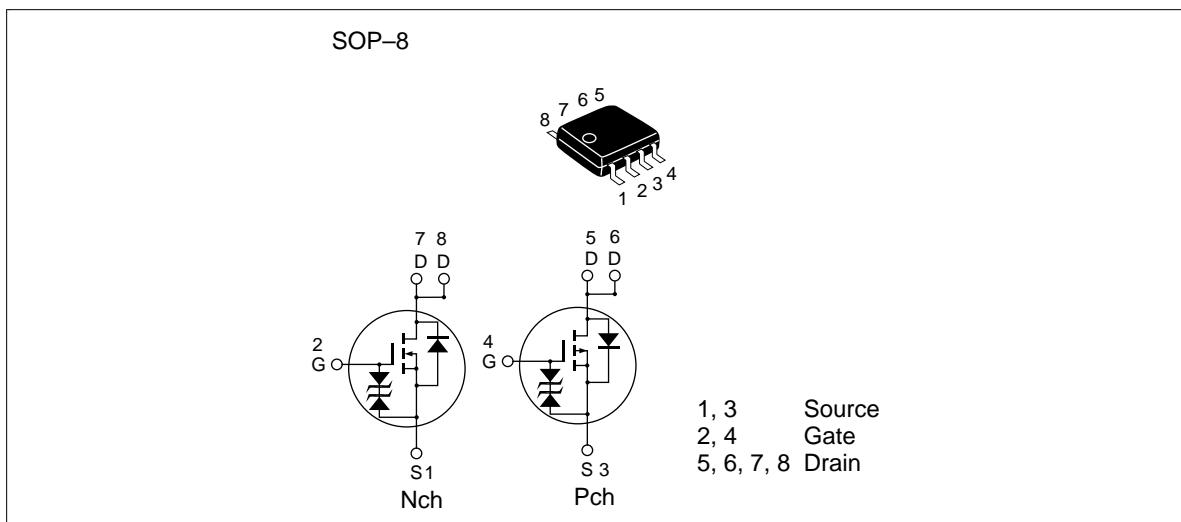
HITACHI

ADE-208-480 E (Z)
6th. Edition
June 1997

Features

- Low on-resistance
- Capable of 4 V gate drive
- Low drive current
- High density mounting

Outline



HAT3006R

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings		Unit
		Nch	Pch	
Drain to source voltage	V _{DSS}	30	-30	V
Gate to source voltage	V _{GSS}	±20	±20	V
Drain current	I _D	6.5	-4.5	A
Drain peak current	I _{D(pulse)} ^{Note1}	52	-36	A
Body-drain diode reverse drain current	I _{DR}	6.5	-4.5	A
Channel dissipation	Pch ^{Note2}	2		W
Channel dissipation	Pch ^{Note3}	3		W
Channel temperature	T _{ch}	150		°C
Storage temperature	T _{stg}	-55 to +150		°C

Note: 1. PW ≤ 10μs, duty cycle ≤ 1 %

2. 1 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW≤ 10s

3. 2 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW≤ 10s

HAT3006R

Electrical Characteristics (N channel) (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	—	—	V	I _D = 10mA, V _{GS} = 0
Gate to source breakdown voltage	V _{(BR)GSS}	±20	—	—	V	I _G = ±100μA, V _{DS} = 0
Gate to source leak current	I _{GSS}	—	—	±10	μA	V _{GS} = ±16V, V _{DS} = 0
Zero gate voltage drain current	I _{DSS}	—	—	10	μA	V _{DS} = 30 V, V _{GS} = 0
Gate to source cutoff voltage	V _{GS(off)}	1.0	—	2.0	V	V _{DS} = 10V, I _D = 1mA
Static drain to source on state resistance	R _{DS(on)}	—	0.03	0.045	Ω	I _D = 4A, V _{GS} = 10V ^{Note4}
Forward transfer admittance	Y _{fs}	5	8	—	S	I _D = 4A, V _{DS} = 10V ^{Note4}
Input capacitance	C _{iss}	—	560	—	pF	V _{DS} = 10V
Output capacitance	C _{oss}	—	380	—	pF	V _{GS} = 0
Reverse transfer capacitance	C _{rss}	—	170	—	pF	f = 1MHz
Turn-on delay time	t _{d(on)}	—	30	—	ns	V _{GS} = 4V, I _D = 4A
Rise time	t _r	—	270	—	ns	V _{DD} ≈ 10V
Turn-off delay time	t _{d(off)}	—	40	—	ns	
Fall time	t _f	—	65	—	ns	
Body-drain diode forward voltage	V _{DF}	—	0.9	1.4	V	IF = 6.5A, V _{GS} = 0 ^{Note4}
Body-drain diode reverse recovery time	t _{rr}	—	45	—	ns	IF = 6.5A, V _{GS} = 0 dI/dt = 20A/μs

Note: 4. Pulse test

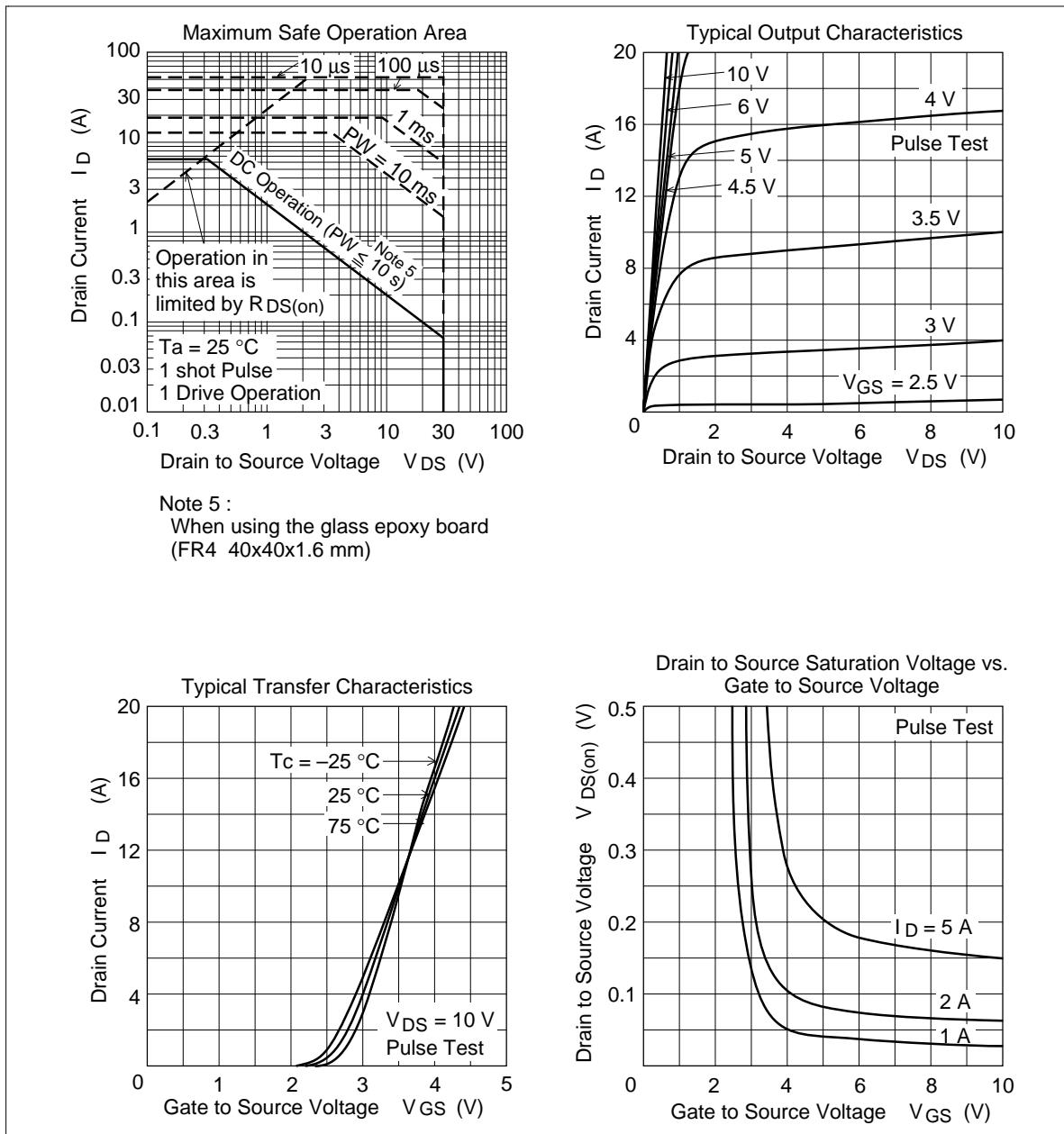
HAT3006R

Electrical Characteristics (P channel) (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	-30	—	—	V	I _D = -10mA, V _{GS} = 0
Gate to source breakdown voltage	V _{(BR)GSS}	±20	—	—	V	I _G = ±100µA, V _{DS} = 0
Gate to source leak current	I _{GSS}	—	—	±10	µA	V _{GS} = ±16V, V _{DS} = 0
Zero gate voltage drain current	I _{DSS}	—	—	-10	µA	V _{DS} = -30 V, V _{GS} = 0
Gate to source cutoff voltage	V _{GS(off)}	-1.0	—	-2.5	V	V _{DS} = -10V, I _D = -1mA
Static drain to source on state resistance	R _{DS(on)}	—	0.07	0.09	Ω	I _D = -3A, V _{GS} = -10V ^{Note5}
Forward transfer admittance	y _{fs}	4	6	—	S	I _D = -3A, V _{DS} = -10V ^{Note5}
Input capacitance	C _{iss}	—	660	—	pF	V _{DS} = -10V
Output capacitance	C _{oss}	—	440	—	pF	V _{GS} = 0
Reverse transfer capacitance	C _{rss}	—	140	—	pF	f = 1MHz
Turn-on delay time	t _{d(on)}	—	24	—	ns	V _{GS} = -4V, I _D = -3A
Rise time	t _r	—	165	—	ns	V _{DD} ≈ -10V
Turn-off delay time	t _{d(off)}	—	35	—	ns	
Fall time	t _f	—	70	—	ns	
Body-drain diode forward voltage	V _{DF}	—	-0.9	-1.4	V	IF = -4.5A, V _{GS} = 0 ^{Note5}
Body-drain diode reverse recovery time	t _{rr}	—	60	—	ns	IF = -4.5A, V _{GS} = 0 dI/dt = 20A/µs

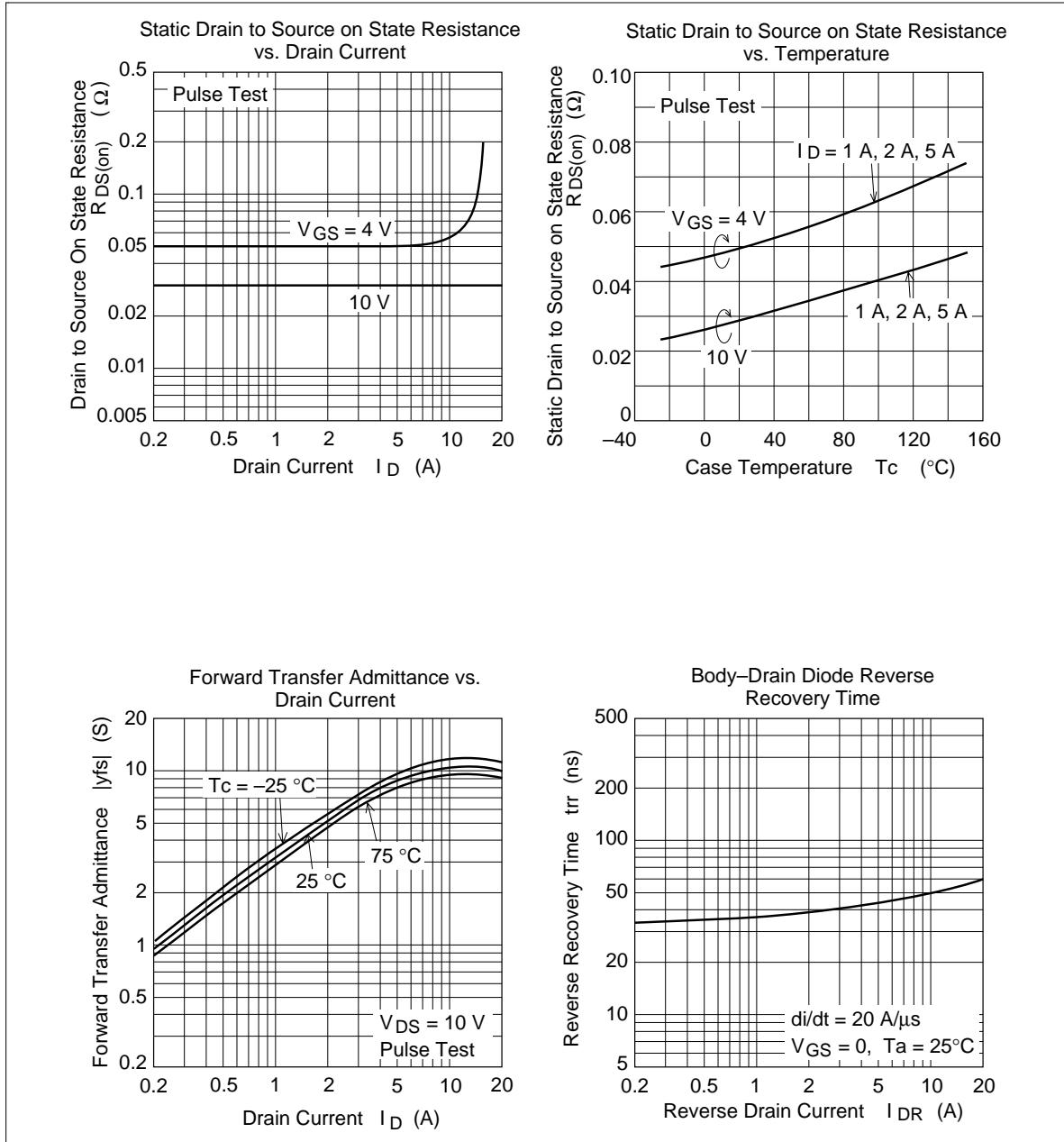
Note: 5. Pulse test

Main Characteristics (N channel)

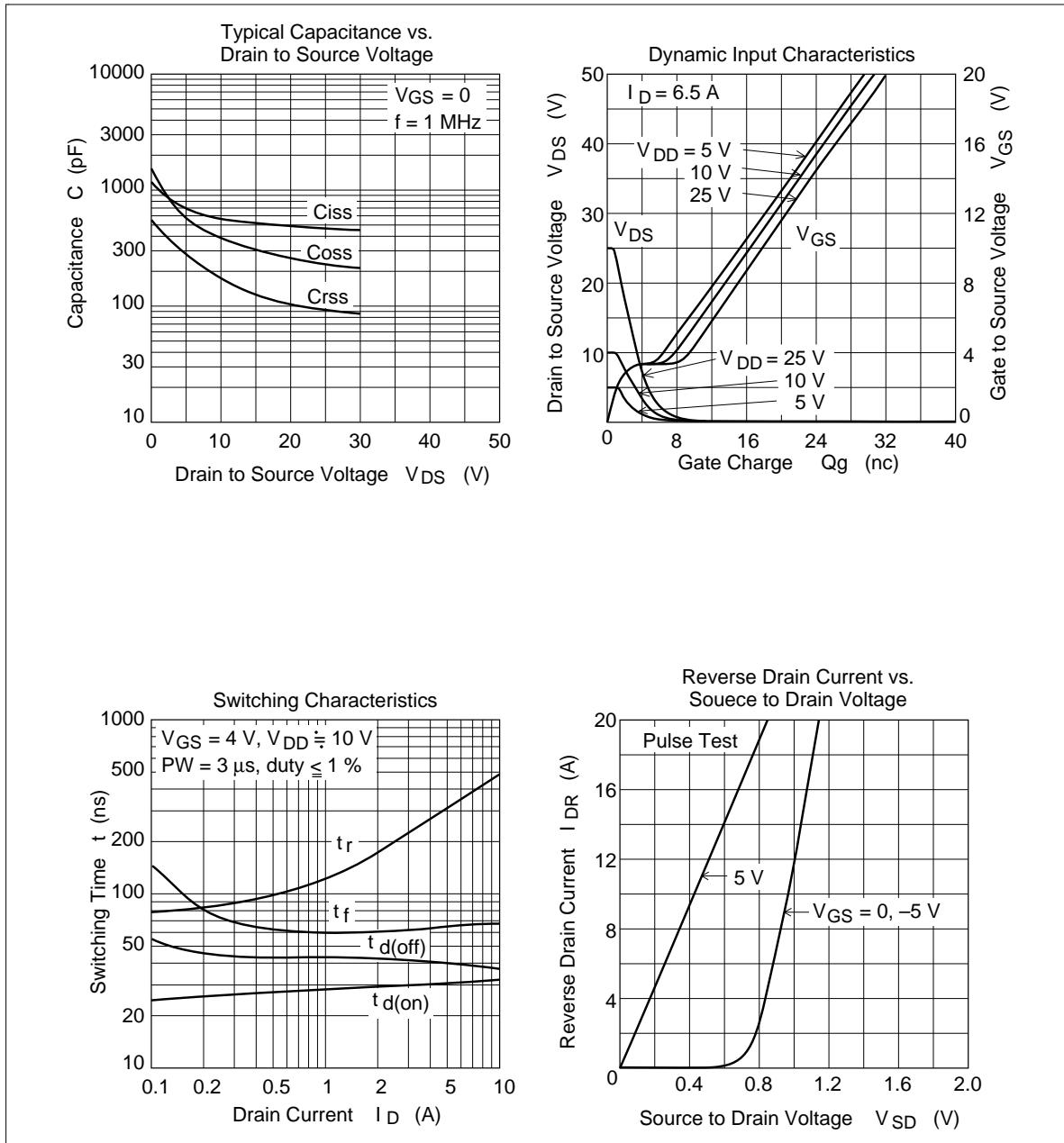


HAT3006R

Main Characteristics (N channel)

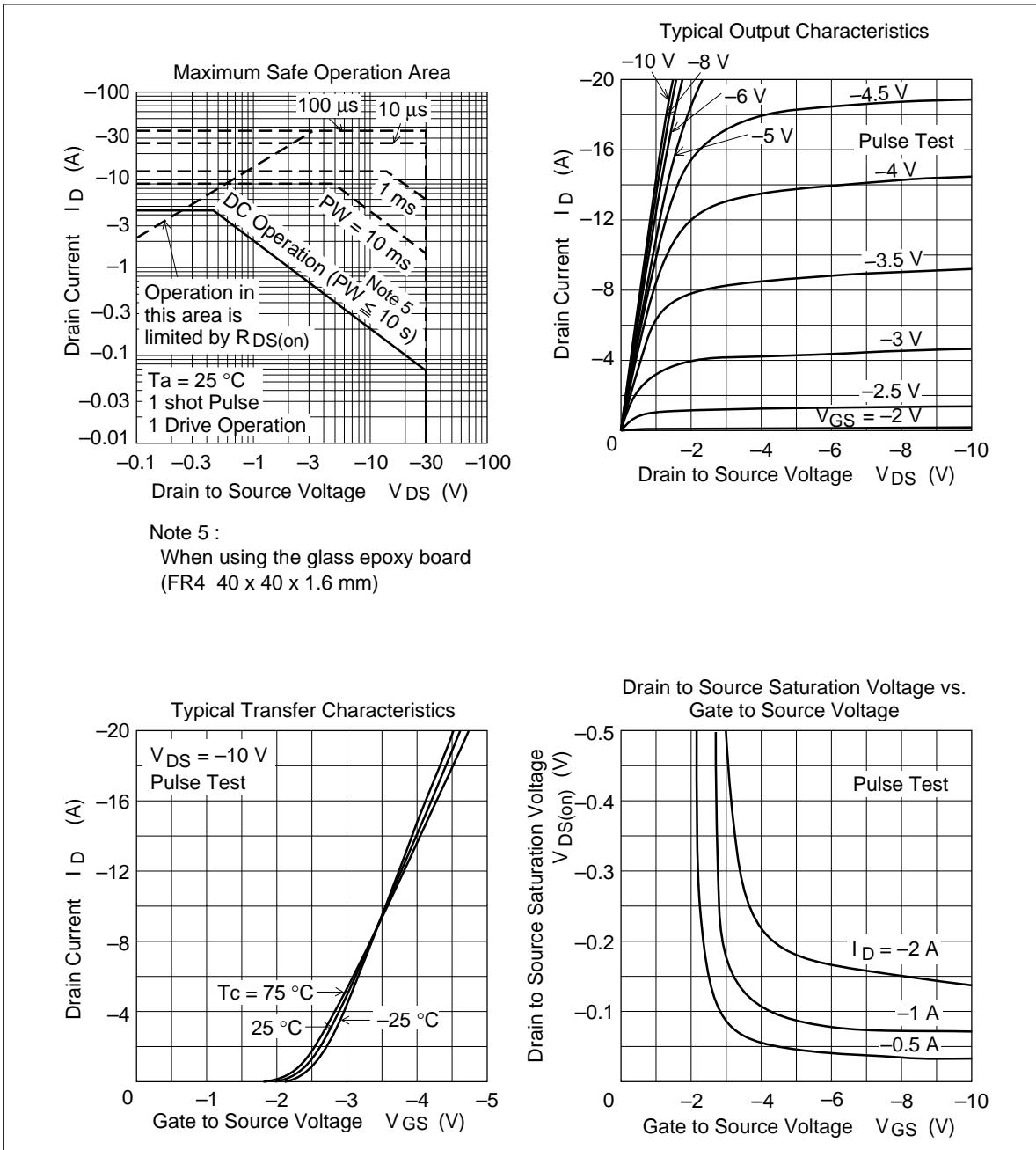


Main Characteristics (N channel)

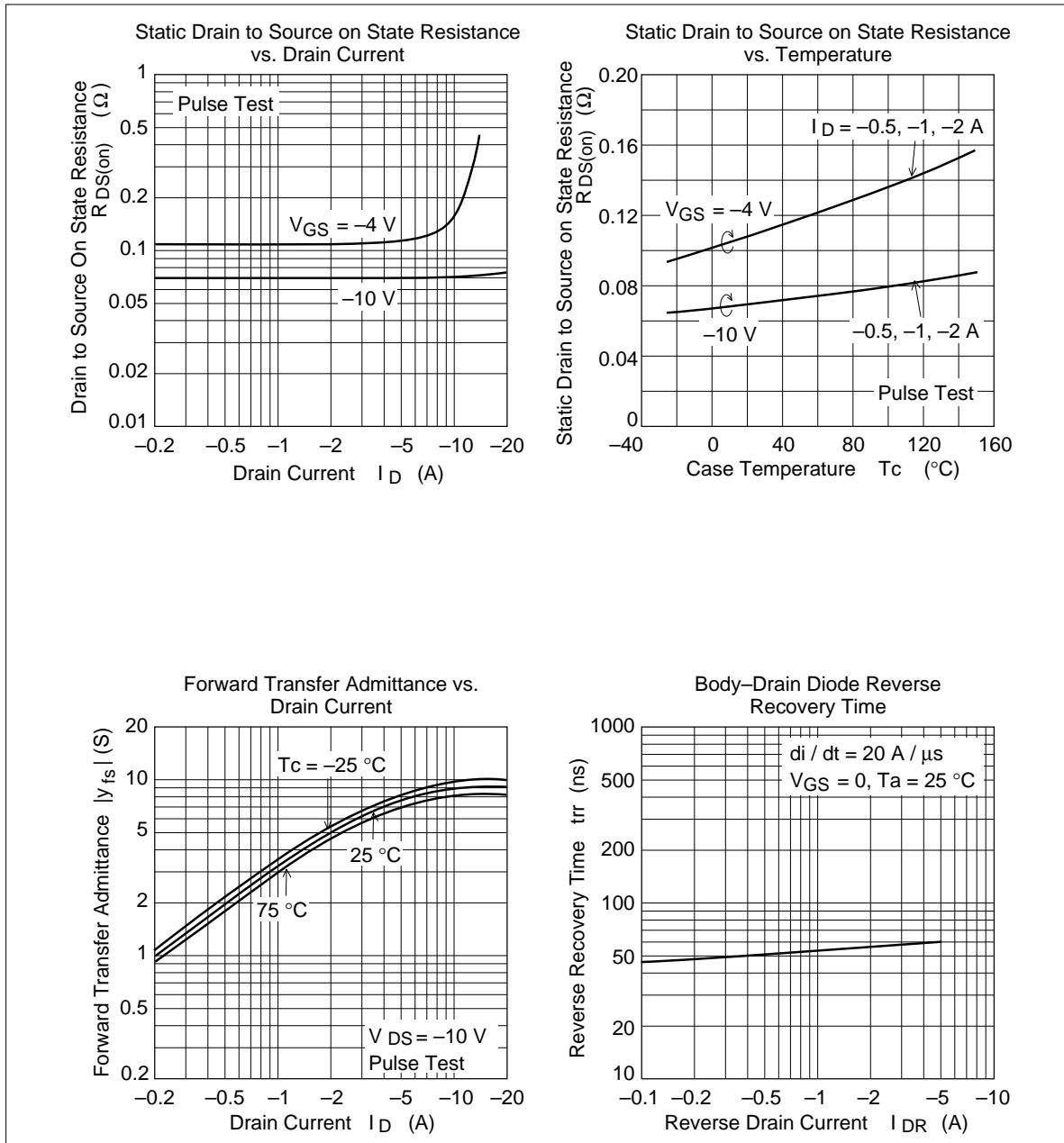


HAT3006R

Main Characteristics (P channel)

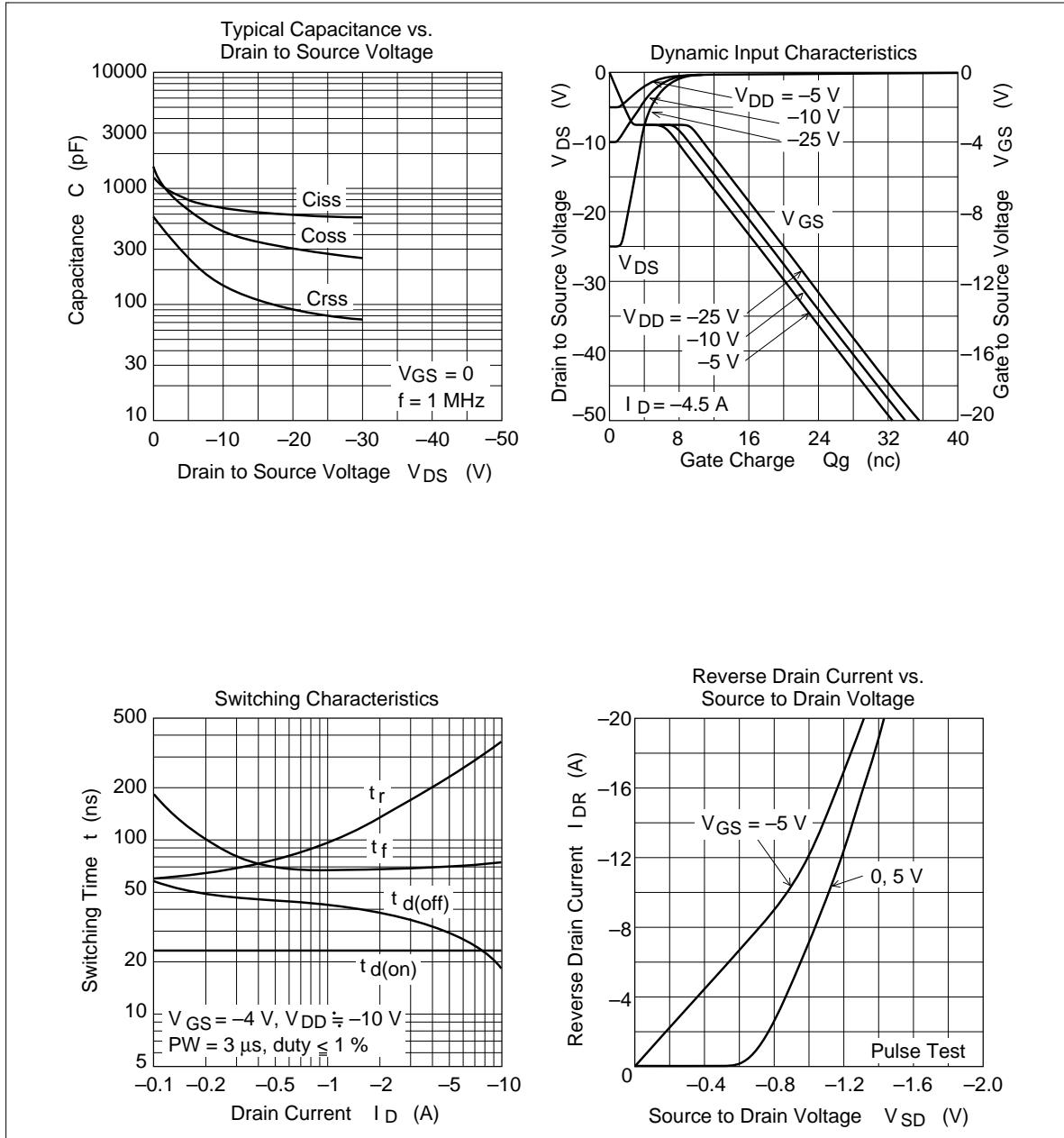


Main Characteristics (P channel)

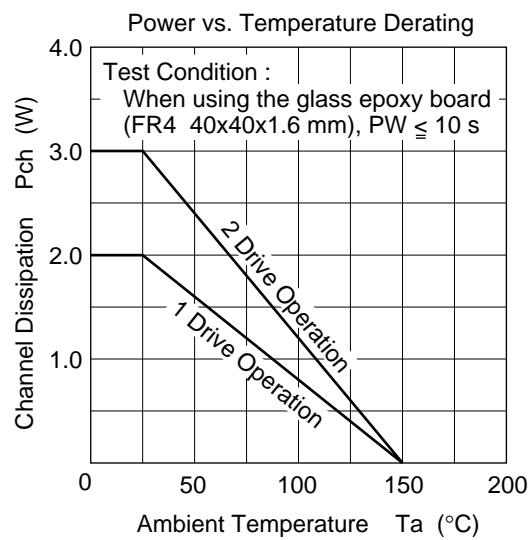


HAT3006R

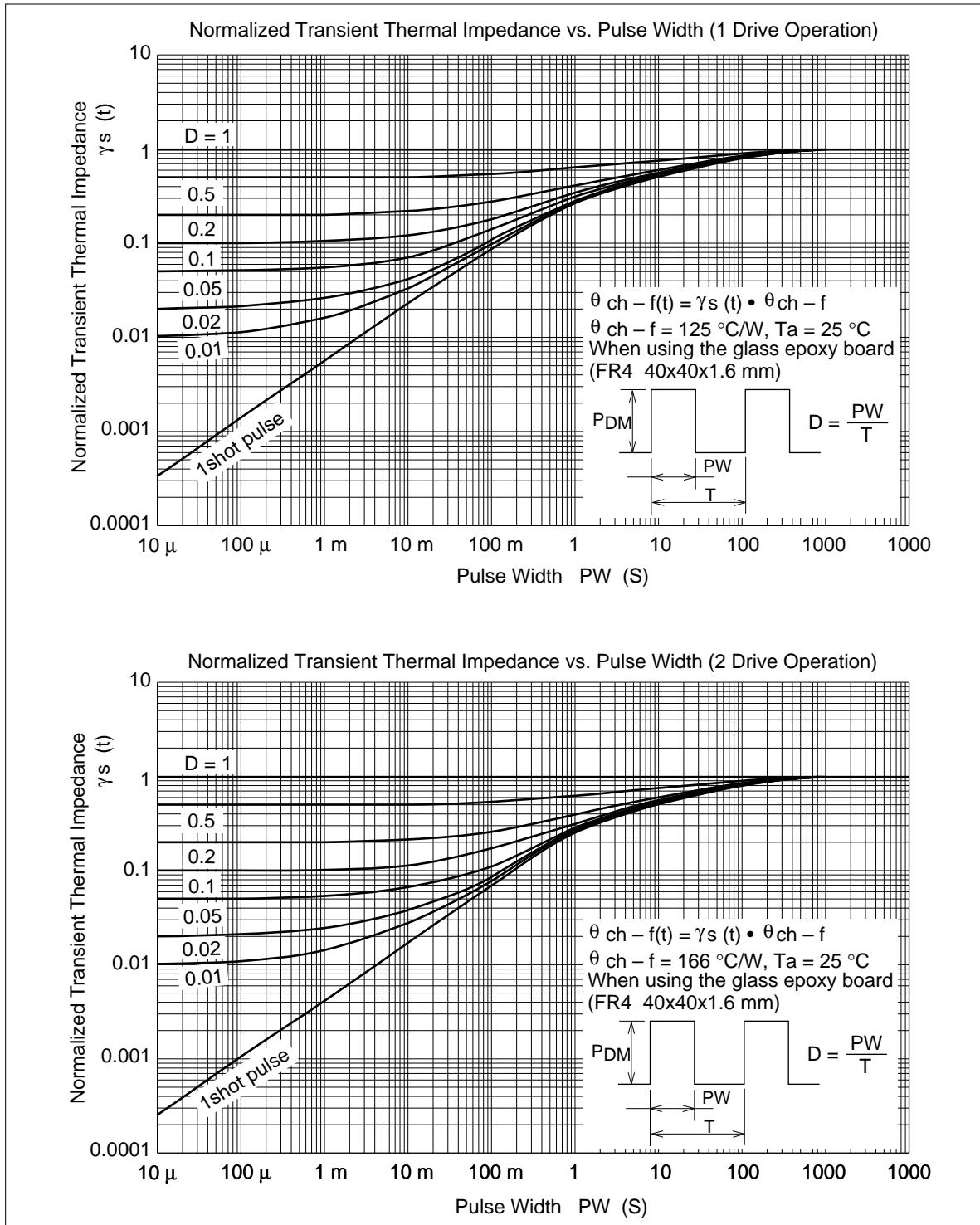
Main Characteristics (P channel)

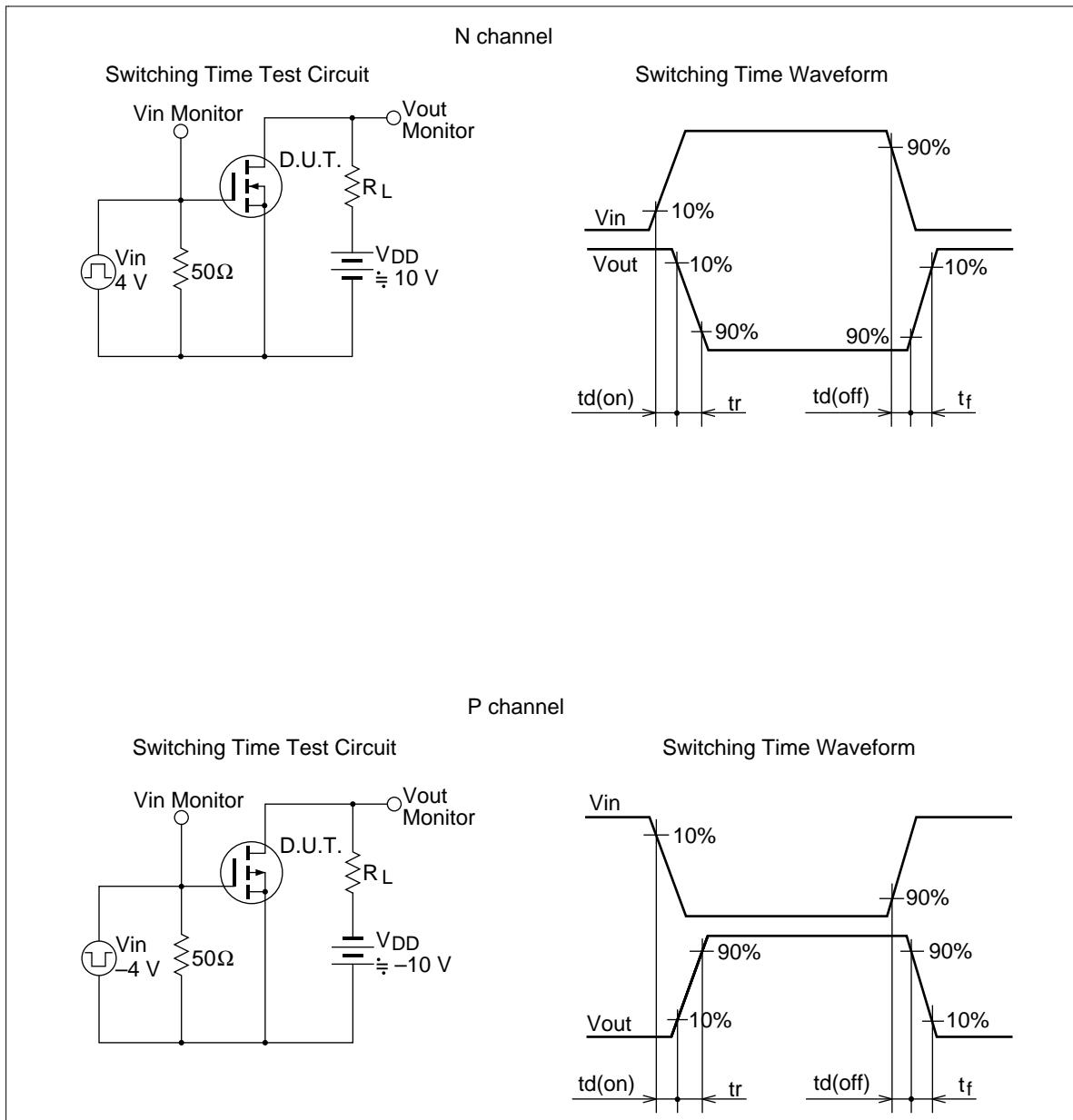


HAT3006R



HAT3006R

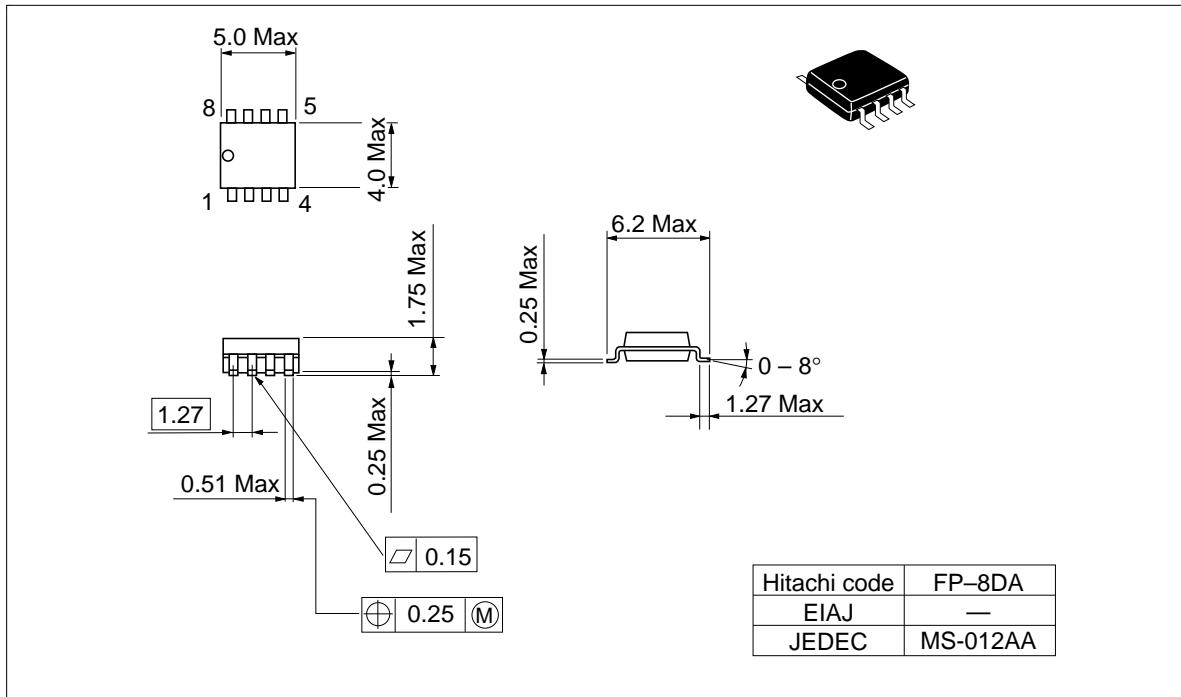




HAT3006R

Package Dimensions

Unit: mm



When using this document, keep the following in mind:

1. This document may, wholly or partially, be subject to change without notice.
2. All rights are reserved: No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without Hitachi's permission.
3. Hitachi will not be held responsible for any damage to the user that may result from accidents or any other reasons during operation of the user's unit according to this document.
4. Circuitry and other examples described herein are meant merely to indicate the characteristics and performance of Hitachi's semiconductor products. Hitachi assumes no responsibility for any intellectual property claims or other problems that may result from applications based on the examples described herein.
5. No license is granted by implication or otherwise under any patents or other rights of any third party or Hitachi, Ltd.
6. MEDICAL APPLICATIONS: Hitachi's products are not authorized for use in MEDICAL APPLICATIONS without the written consent of the appropriate officer of Hitachi's sales company. Such use includes, but is not limited to, use in life support systems. Buyers of Hitachi's products are requested to notify the relevant Hitachi sales offices when planning to use the products in MEDICAL APPLICATIONS.

HITACHI

Hitachi, Ltd.

Semiconductor & IC Div.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan
Tel: Tokyo (03) 3270-2111
Fax: (03) 3270-5109

For further information write to:

Hitachi America, Ltd. Semiconductor & IC Div. 2000 Sierra Point Parkway Brisbane, CA. 94005-1835 U S A Tel: 415-589-8300 Fax: 415-583-4207	Hitachi Europe GmbH Electronic Components Group Continental Europe Dornacher Straße 3 D-85622 Feldkirchen München Tel: 089-9 91 80-0 Fax: 089-9 29 30 00	Hitachi Europe Ltd. Electronic Components Div. Northern Europe Headquarters Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA United Kingdom Tel: 0628-585000 Fax: 0628-778322	Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 0104 Tel: 535-2100 Fax: 535-1533	Hitachi Asia (Hong Kong) Ltd. Unit 706, North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon Hong Kong Tel: 27359218 Fax: 27306071
--	---	---	---	--

Copyright © Hitachi, Ltd., 1997. All rights reserved. Printed in Japan.